**ON Semiconductor** 

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# Onsemi

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## NPN - MPS6601; PNP - MPS6651, MPS6652

MPS6652 is a Preferred Device

### **Amplifier Transistors**

#### Features

- Voltage and Current are Negative for PNP Transistors
- Pb–Free Packages are Available\*

#### MAXIMUM RATINGS

| Rating  | Symbol                            | Value       | Unit       |
|---|-----------------------------------|-------------|------------|
| Collector – Emitter Voltage<br>MPS6601/6651<br>MPS6652                | V <sub>CEO</sub>                  | 25<br>40    | Vdc        |
| Collector – Base Voltage<br>MPS6601/6651<br>MPS6652                   | V <sub>CBO</sub>                  | 25<br>30    | Vdc        |
| Emitter-Base Voltage  | V <sub>EBO</sub>                  | 4.0         | Vdc        |
| Collector Current – Continuous  | Ι <sub>C</sub>                    | 1000        | mAdc       |
| Total Device Dissipation @ $T_A = 25^{\circ}C$<br>Derate above 25°C   | P <sub>D</sub>                    | 625<br>5.0  | W<br>mW/°C |
| Total Device Dissipation @ T <sub>C</sub> = 25°C<br>Derate above 25°C | PD                                | 1.5<br>12   | W<br>mW/°C |
| Operating and Storage Junction<br>Temperature Range                   | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150 | °C         |

#### THERMAL CHARACTERISTICS

| Characteristic                                   | Symbol          | Max  | Unit |
|--|-----------------|------|------|
| Thermal Resistance, Junction-to-Ambient (Note 1) | $R_{\theta JA}$ | 200  | °C/W |
| Thermal Resistance, Junction-to-Case             | $R_{\theta JC}$ | 83.3 | °C/W |

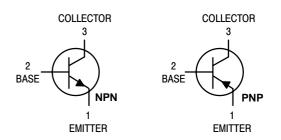
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

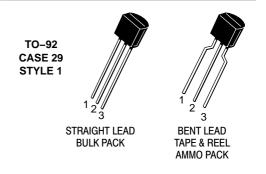
1.  $R_{\theta,IA}$  is measured with the device soldered into a typical printed circuit board.

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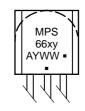
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#### MARKING DIAGRAM



| MPS66xy                  | = Device Code             |  |
|--------------------------|---------------------------|--|
| -                        | x = 0 or 5                |  |
|                          | y = 1 or 2                |  |
| А                        | = Assembly Location       |  |
| Υ                        | = Year                    |  |
| WW                       | = Work Week               |  |
| •                        | = Pb–Free Package         |  |
| ote <sup>.</sup> Microdo | t may be in either locati |  |

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

Preferred devices are recommended choices for future use

and best overall value.

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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#### NPN - MPS6601; PNP - MPS6651, MPS6652

#### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

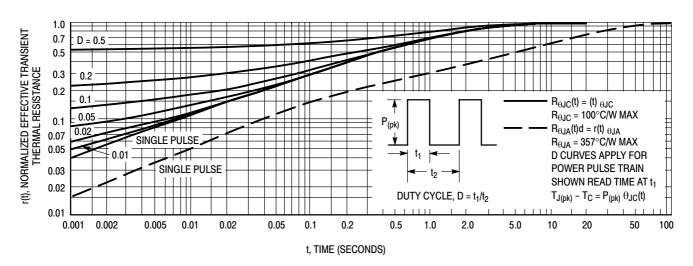
| Chara   | acteristic  | Symbol               | Min            | Max        | Unit |
|---|---|----------------------|----------------|------------|------|
| OFF CHARACTERISTICS   |   |                      |                |            |      |
| Collector – Emitter Breakdown Voltage<br>( $I_C = 1.0 \text{ mAdc}, I_B = 0$ )  | MPS6601/6651<br>MPS6652   | V <sub>(BR)CEO</sub> | 25<br>40       |            | Vdc  |
| Collector – Base Breakdown Voltage<br>( $I_C = 100 \ \mu Adc, I_E = 0$ )  | MPS6601/6651<br>MPS6652   | V <sub>(BR)CBO</sub> | 25<br>40       |            | Vdc  |
| Emitter – Base Breakdown Voltage $(I_E = 10 \ \mu Adc, I_C = 0)$  |   | V <sub>(BR)EBO</sub> | 4.0            | -          | Vdc  |
| $      Collector Cutoff Current \\ (V_{CE} = 25 \text{ Vdc}, \text{ I}_{B} = 0) \\ (V_{CE} = 30 \text{ Vdc}, \text{ I}_{B} = 0) $ | MPS6601/6651<br>MPS6652   | I <sub>CES</sub>     |                | 0.1<br>0.1 | μAdc |
| $      Collector Cutoff Current \\ (V_{CB} = 25 Vdc, I_E = 0) \\ (V_{CB} = 30 Vdc, I_E = 0) $                                     | MPS6601/6651<br>MPS6652   | I <sub>СВО</sub>     |                | 0.1<br>0.1 | μAdc |
| ON CHARACTERISTICS  |   |                      |                |            |      |
|   |   | h <sub>FE</sub>      | 50<br>50<br>30 |            | _    |
| Collector – Emitter Saturation Voltage $(I_C = 1000 \text{ mAdc}, I_B = 100 \text{ mAdc})$  |   | V <sub>CE(sat)</sub> | -              | 0.6        | Vdc  |
| Base–Emitter On Voltage<br>(I <sub>C</sub> = 500 mAdc, V <sub>CE</sub> = 1.0 Vdc)   |   | V <sub>BE(on)</sub>  | -              | 1.2        | Vdc  |
| SMALL-SIGNAL CHARACTERISTICS  | ;<br>;  |                      | •              | •          |      |
| $\begin{array}{l} Current-Gain - Bandwidth \ Product \\ (I_C = 50 \ mAdc, \ V_{CE} = 10 \ Vdc, \ f = 1 \end{array}$               | 00 MHz)   | f <sub>T</sub>       | 100            | _          | MHz  |
| Output Capacitance $(V_{CB} = 10 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz})$  | )   | C <sub>obo</sub>     | _              | 30         | pF   |
| SWITCHING CHARACTERISTICS   |   |                      |                |            |      |
| Delay Time  |   | t <sub>d</sub>       | -              | 25         | ns   |
| Rise Time   | $(V_{CC} = 40 \text{ Vdc}, I_C = 500 \text{ mAdc}, I_{B1} = 50 \text{ mAdc},$ | t <sub>r</sub>       | -              | 30         | ns   |
| Storage Time  | $t_p \ge 300 \text{ ns Duty Cycle})$  | t <sub>s</sub>       | -              | 250        | ns   |
| Fall Time   |   | t <sub>f</sub>       | _              | 50         | ns   |

#### ORDERING INFORMATION

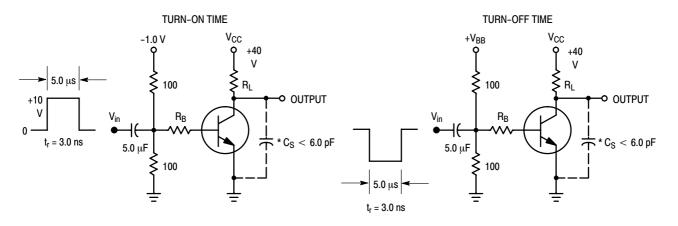
| Device       | Package                     | Shipping <sup>†</sup>    |
|--------------|-----------------------------|--------------------------|
| MPS6601RLRAG | TO-92 (TO-226)<br>(Pb-Free) | 2000 Units / Tape & Reel |
| MPS6651G     | TO-92 (TO-226)<br>(Pb-Free) |                          |
| MPS6652      | TO-92 (TO-226)              | 5000 Units / Bulk        |
| MPS6652G     | TO-92 (TO-226)<br>(Pb-Free) |                          |
| MPS6652RLRAG | TO-92 (TO-226)<br>(Pb-Free) | 2000 Units / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

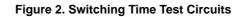
NPN – MPS6601; PNP – MPS6651, MPS6652

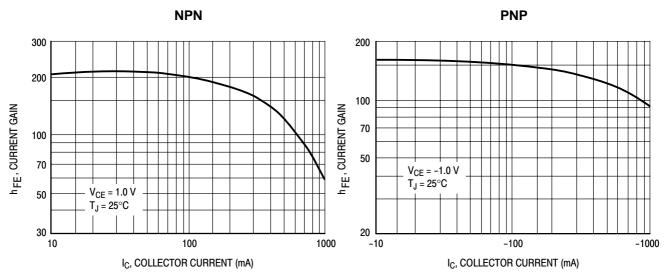






\*Total Shunt Capacitance of Test Jig and Connectors For PNP Test Circuits, Reverse All Voltage Polarities





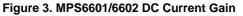


Figure 4. MPS6651/6652 DC Current Gain

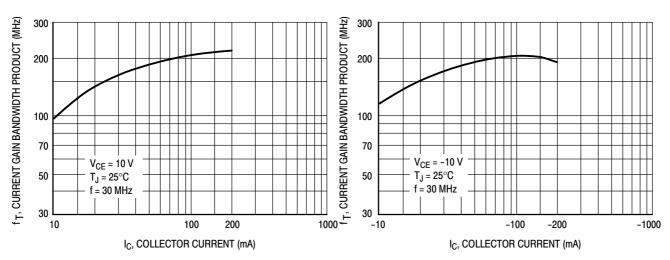
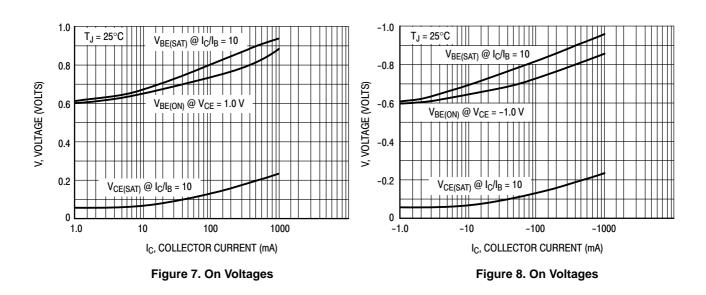
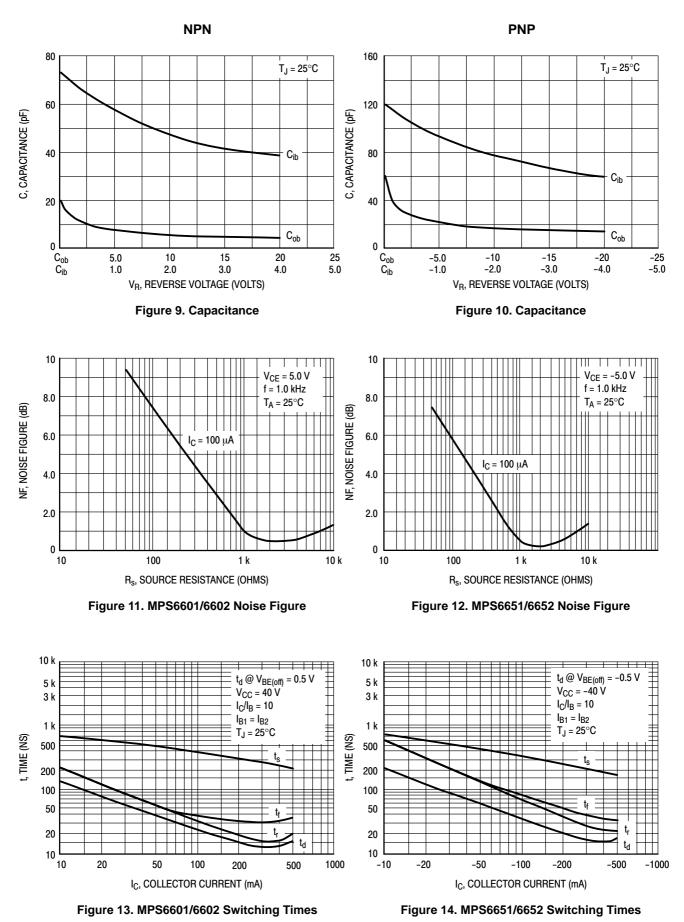


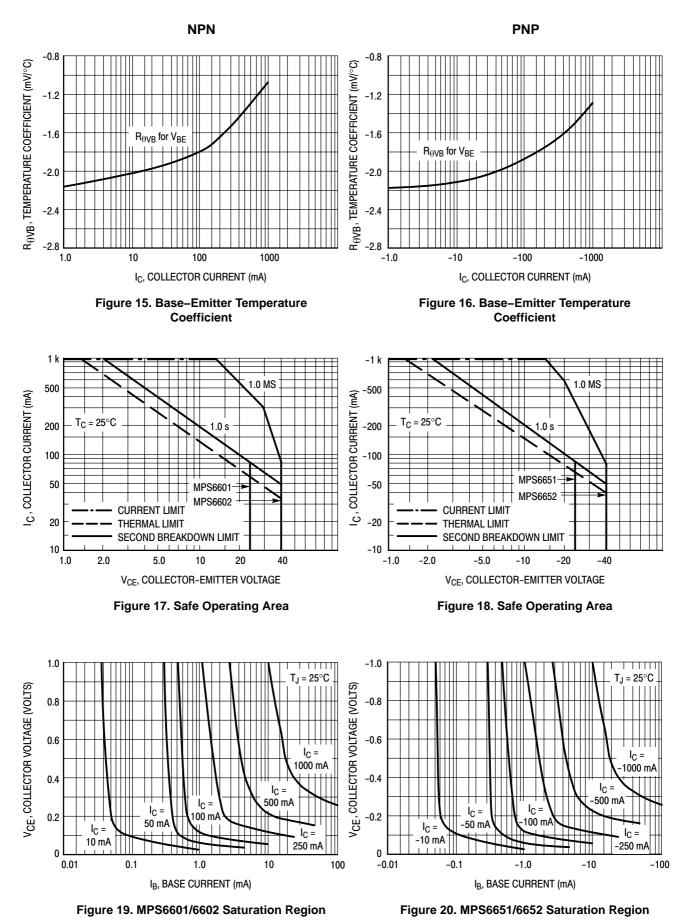
Figure 5. Current Gain Bandwidth Product

Figure 6. Current Gain Bandwidth Product



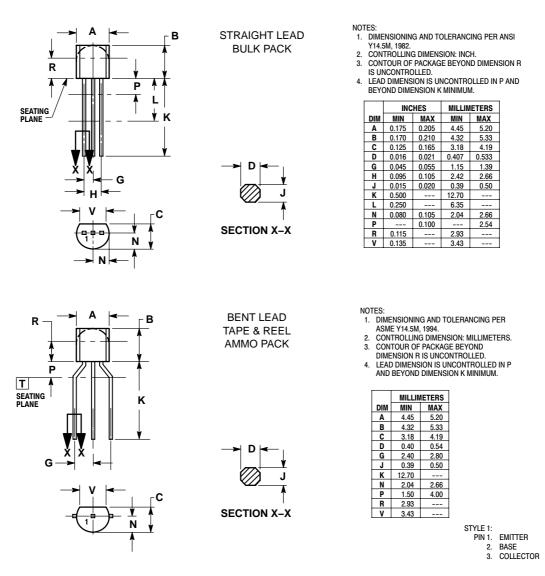


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#### PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 ISSUE AM



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